



100V N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _{D MAX} T _C = +25°C
100V	8.5mΩ @ V _{GS} = 10V	50A
1000	12.5mΩ @ V _{GS} = 4.5V	41A

Description

This MOSFET is designed to minimize the on-state resistance ($R_{\rm DS(ON)}$) and yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

Applications

- Synchronous Rectifier
- Backlighting
- Power Management Functions
- DC-DC Converters

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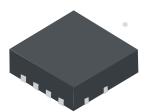
Bottom View

Features and Benefits

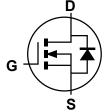
- Low R_{DS(ON)} Ensures On State Losses are Minimized
- Excellent Q_{qd x} R_{DS (ON)} Product (FOM)
- Advanced Technology for DC/DC Converters
- Small Form Factor Thermally Efficient Package Enables Higher Density End Products
- Occupies Just 33% of the Board Area Occupied by SO-8 Enabling Smaller End Product
- 100% Unclamped Inductive Switching (UIS) Test in Production Ensures More Reliable and Robust End Application
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen- and Antimony-Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Case: PowerDI[®]3333-8
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish—Matte Tin Annealed over Copper Lead-Frame.
 Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.034 grams (Approximate)



Top View



Equivalent Circuit

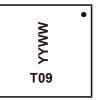
Ordering Information (Note 4)

Part Number	Case	Packaging
DMT10H009LFG-7	PowerDI3333-8	2,000/Tape & Reel
DMT10H009LFG-13	PowerDI3333-8	3,000/Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website athttps://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



T09 = Product Type Marking Code YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 20 = 2020) WW = Week Code (01 to 53)



Maximum Ratings (@ $T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Drain-Source Voltage		V _{DSS}	100	V	
Gate-Source Voltage		V _{GSS}	±20	V	
	T _A = +25°C	,	13		
Continuous Drain Correct (Nata 5) V = 40V	T _A = +70°C	I _D	11	A	
Continuous Drain Current (Note 5) V _{GS} = 10V	T _C = +25°C	,	50	Δ.	
	T _C = +70°C	ID	40	Α	
Maximum Continuous Body Diode Forward Current (Note 5)	I _S	25	Α		
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I _{DM}	200	Α		
Pulsed Body Diode Continuous Current (10µs Pulse, Duty C	I _{SM}	200	А		
Avalanche Current (L = 1mH)		I _{AS}	17	А	
Avalanche Energy (L = 1mH)		E _{AS}	144.5	mJ	

Thermal Characteristics (@ $T_A = \pm 25^{\circ}C$, unless otherwise specified.)

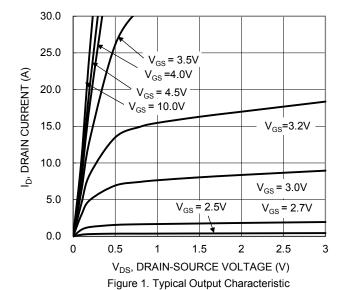
Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 5) T _A = +25°C		P_{D}	2	W
Thermal Resistance, Junction to Ambient (Note 5)	$R_{ heta JA}$	59	°C/W	
Total Power Dissipation	P_{D}	30	W	
Thermal Resistance, Junction to Case		$R_{ heta JC}$	3.8	°C/W
Operating and Storage Temperature Range		T _{J,} T _{STG}	-55 to +150	°C

Electrical Characteristics (@ T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 6)							
Drain-Source Breakdown Voltage	BV_{DSS}	100	_	_	V	V_{GS} = 0V, I_D = 1mA	
Zero Gate Voltage Drain Current	I _{DSS}	_	_	1	μΑ	$V_{DS} = 80V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 6)						·	
Gate Threshold Voltage	V _{GS(TH)}	1.1	_	2.5	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	
Static Drain-Source On-Resistance	_	_	6.4	8.5	mΩ	V _{GS} = 10V, I _D = 20A	
Static Dialii-Source Oil-Resistance	R _{DS(ON)}	_	8.2	12.5	11122	$V_{GS} = 4.5V, I_D = 10A$	
Diode Forward Voltage	V_{SD}	_	8.0	1.2	V	$V_{GS} = 0V, I_{S} = 20A$	
DYNAMIC CHARACTERISTICS (Note 7)						·	
Input Capacitance	C _{iss}	_	2361	_	pF	V _{DS} = 50V, V _{GS} = 0V f = 1MHz	
Output Capacitance	Coss	_	611	_			
Reverse Transfer Capacitance	C _{rss}	_	16	_			
Gate Resistance	Rg	_	1.7	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge	Qg	_	41	_		V 50V L 40A	
Gate-Source Charge	Q _{qs}		7.3	_	nC	$V_{DD} = 50V, I_{D} = 13A,$ $V_{GS} = 10V$	
Gate-Drain Charge	Q_{qd}	_	9.3	_			
Turn-On Delay Time	t _{D(ON)}		7	_		$V_{DD} = 50V, V_{GS} = 10V,$ $I_{D} = 13A, R_{g} = 6\Omega$	
Turn-On Rise Time	t _R	_	12	_			
Turn-Off Delay Time	t _{D(OFF)}		42	_	ns		
Turn-Off Fall Time	t _F	_	24	_			
Reverse Recovery Time	t _{RR}	_	45	_	ns	104 11/11 1004/	
Reverse Recovery Charge	Q_{RR}	_	68	_	nC	I _F = 13A, di/dt = 100A/μs	

5. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.6. Short duration pulse test used to minimize self-heating effect.7. Guaranteed by design. Not subject to product testing. Notes:





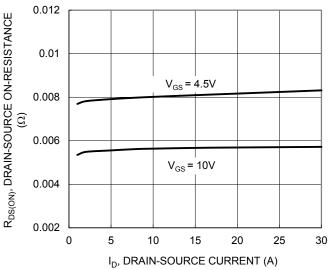


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

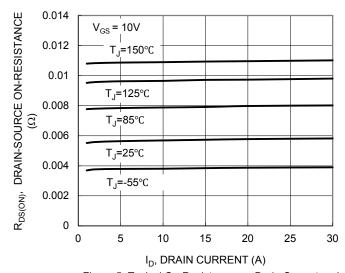
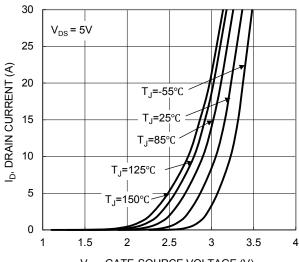


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature



V_{GS}, GATE-SOURCE VOLTAGE (V) Figure 2. Typical Transfer Characteristic

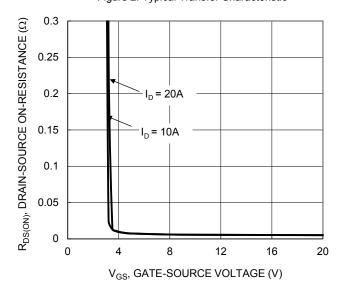
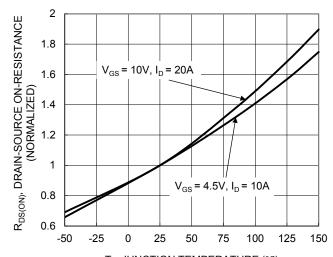


Figure 4. Typical Transfer Characteristic



 $T_{\rm J}$, JUNCTION TEMPERATURE (°C) Figure 6. On-Resistance Variation with Junction Temperature



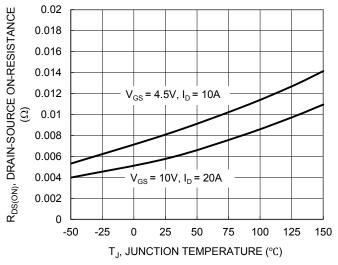


Figure 7. On-Resistance Variation with Junction Temperature

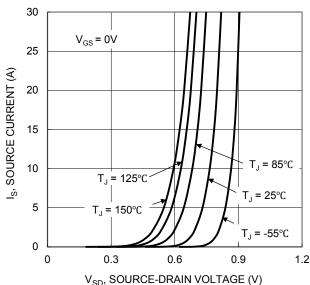


Figure 9. Diode Forward Voltage vs. Current

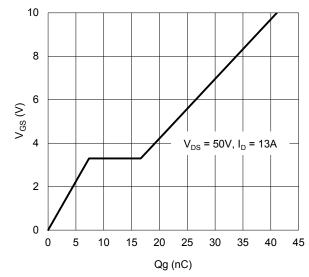


Figure 11. Gate Charge

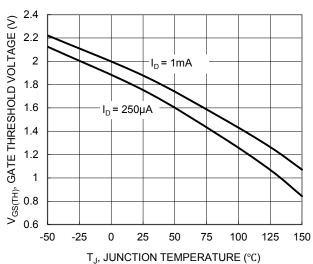
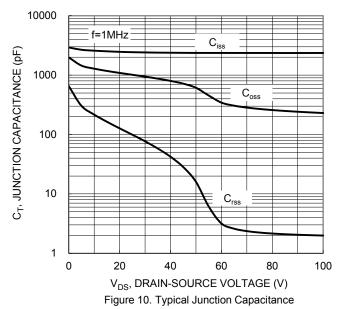


Figure 8. Gate Threshold Variation vs. Junction Temperature



1000 $R_{DS(ON)}$ Limited ,=1µs P_w =10μs 100 ID, DRAIN CURRENT (A) 10 P_W =10ms P_W =100ms 1 $T_{J(Max)} = 150^{\circ}C$ $T_C = 25^{\circ}C$ Single Pulse DC DUT on Infinite Heatsink V_{GS}= 10V 0.01 0.1 100 1000

V_{DS}, DRAIN-SOURCE VOLTAGE (V) Figure 12. SOA, Safe Operation Area



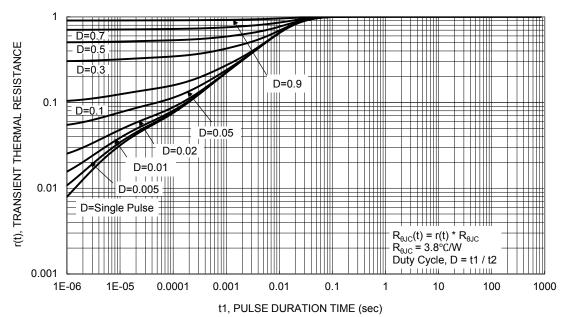


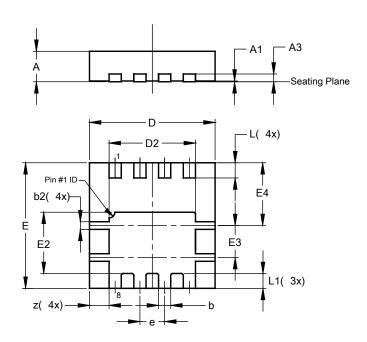
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI3333-8

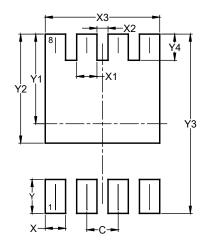


PowerDI3333-8					
Dim	Min	Max	Тур		
Α	0.75	0.85	0.80		
A1	0.00	0.05	0.02		
A3	-	_	0.203		
b	0.27	0.37	0.32		
b2	0.15	0.25	0.20		
D	3.25	3.35	3.30		
D2	2.22	2.32	2.27		
E	3.25	3.35	3.30		
E2	1.56	1.66	1.61		
E3	0.79	0.89	0.84		
E4	1.60	1.70	1.65		
е	_	_	0.65		
L	0.35	0.45	0.40		
L1	_	_	0.39		
Z	_	_	0.515		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI3333-8



Dimensions	Value (in mm)
С	0.650
Х	0.420
X1	0.420
X2	0.230
Х3	2.370
Υ	0.700
Y1	1.850
Y2	2.250
Y3	3.700
Y4	0.540



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